

## **LM73605 / LM73606 EVM User's Guide**

The LM73605 / LM73606 evaluation module (EVM) is designed to help customers evaluate the performance of the LM73605 / LM73606 synchronous step-down voltage converters. The EVM contains one LM73605 or LM73606 device in the 30-pin wettable flanks QFN (WQFN) package, as shown in [Table 1](#). It is capable of delivering 5-V output voltage and up to 5-A (LM73605) or 6-A (LM73606) load current with exceptional efficiency and output accuracy in a very small solution size. The EVM provides multiple power connectors and test points, as well as mode setting options and enable input options, for customer convenience. It also provides a good layout example, which is optimized for EMI performance and thermal performance.

**Table 1. Device and Package Configurations**

CONVERTER	IC	PACKAGE
U1	LM73605	30-pin wettable flanks QFN (WQFN) 6 mm × 4 mm × 0.8 mm
	LM73606	

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### Trademarks

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# 1 Introduction

## 1.1 LM73605 / LM73606 Synchronous Step-Down Voltage Converter

The LM73605/LM73606 family of devices are easy-to-use synchronous step-down DC-DC converters capable of driving up to 5 A (LM73605) or 6 A (LM73606) of load current from a supply voltage ranging from 3.5 V to 36 V. The LM73605/LM73606 provide exceptional efficiency and output accuracy in a very small solution size. Peak-current-mode control is employed. Additional features such as adjustable switching frequency, synchronization to an external clock, FPWM option, power-good flag, precision enable, adjustable soft start, and tracking provide both flexible and easy-to-use solutions for a wide range of applications. Automatic frequency foldback at light load and optional external bias improve efficiency over the entire load range. The family requires few external components and has a pinout designed for simple PCB layout with optimal EMI and thermal performance. Protection features include thermal shutdown, input undervoltage lockout, cycle-by-cycle current limiting, and hiccup short-circuit protection. The LM73605 and LM73606 devices are pin-to-pin compatible for easy current scaling.

The pin configuration of the LM73605/6 is shown in [Figure 1](#) and the schematic is shown in [Figure 2](#) for your quick reference. See the [LM73605/LM73606 data sheet](#) for more detailed feature descriptions and design guide.

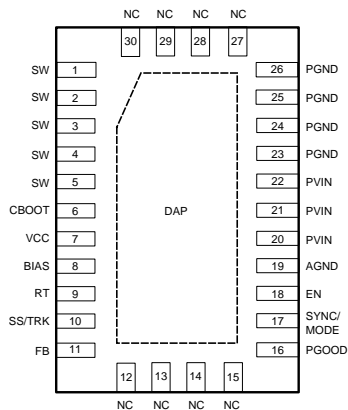
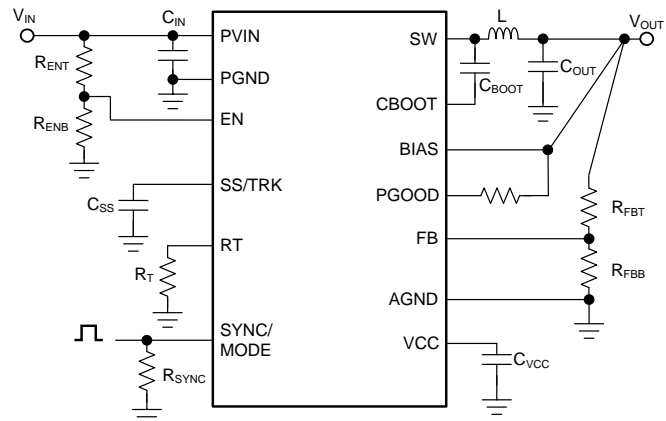


Figure 1. LM73605/6 Pin Configuration (30-Pin WQFN Package Top View)



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Figure 2. LM73605/6 Schematic

## 1.2 LM73605 / LM73606 Evaluation Module

The LM73605 / LM73606 EVM has three variants to cover a wide range of applications. The options include LM73605 (5-A maximum DC output current) with 400-kHz switching frequency and 2.2-MHz switching frequency, and LM73606 (6-A maximum DC output current) with 400-kHz switching frequency, as listed in [Table 2](#). The output voltage is 5 V.

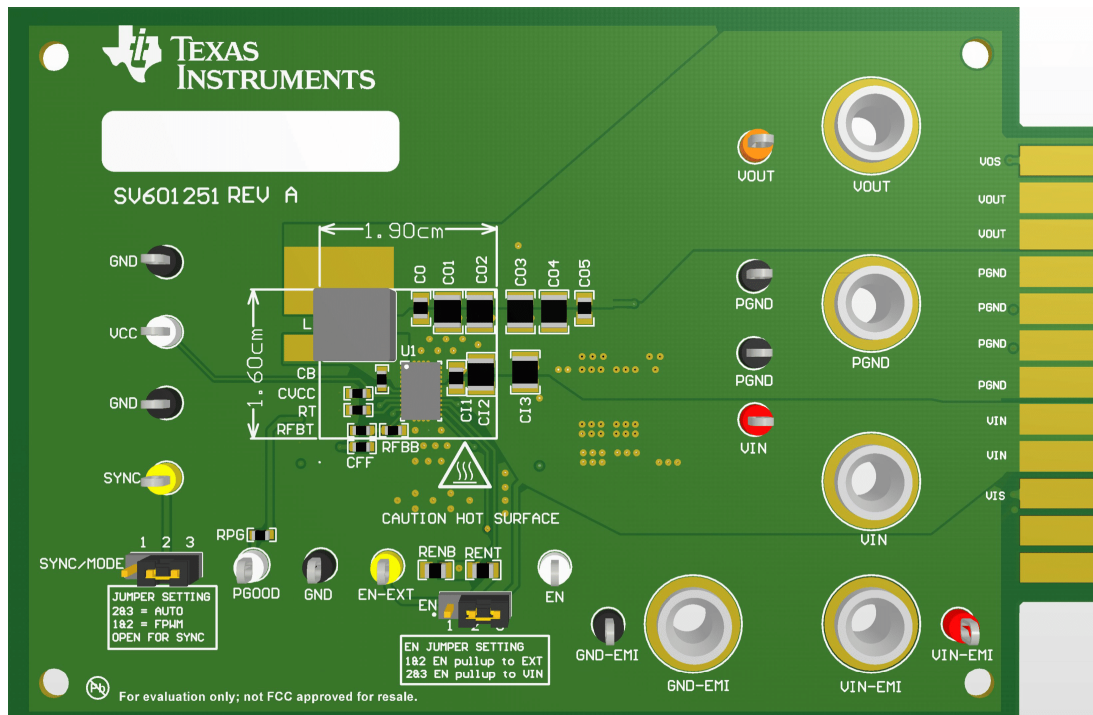
Table 2. EVM Variants

Label	U1	I <sub>OUT</sub>	Switching Frequency	V <sub>IN</sub> Range	V <sub>OUT</sub>
LM73605EVM-5V-2MHz	LM73605	5 A	2.2 MHz	6 to 36 V	5 V
LM73605EVM-5V-400K	LM73605	5 A	400 kHz	6 to 36 V	5 V
LM73606EVM-5V-400K	LM73606	6 A	400 kHz	6 to 36 V	5 V

## 2 Quick Start

1. Connect the voltage supply between VIN and PGND connectors, using short and thick wires.
2. Connect the load of the converter between VOUT and PGND connectors, using short and thick wires.
3. Set the supply voltage ( $V_{IN}$ ) at an appropriate level between 6 V to 36 V. Set the current limit of the supply to an appropriate level as well.
4. Turn on the power supply. With the default configuration, the EVM should power up and provide  $V_{OUT} = 5$  V.
5. Monitor the output voltage. The maximum load current should be 5 A with LM73605, or 6 A with LM73606.

See [Figure 3](#) for the location of the connectors.



**Figure 3. Top View of LM73605/LM73606 EVM**

### 3 Detailed Descriptions

This section describes the connectors and the test points on the EVM and how to properly connect, set up and use the LM73605/LM73606 EVM. See [Figure 3](#) for a top view of the EVM.

**VOUT** — Output voltage of the converter.

VOUT connector and test point connect to the power inductor and the output capacitors. Connect the loading device between VOUT and PGND connectors to provide loading to the converter. Connect the loading device to the board with short and thick wires to handle the large DC output current.

**PGND** — Ground of the converter.

It is connected to the PGND and AGND of the device, as well as the input and output capacitors. PGND is the current return path for both supply voltage and load. Connect to supply and load grounds with short and thick wires.

**VIN** — Input voltage to the converter.

VIN connector and test point connect to the input capacitors and the PVIN pins of the LM73605/LM73606. Connect the supply voltage from a power supply or a battery between VIN and PGND connectors as power input to the board. The voltage range should be higher than 3.5 V for the device to be active.  $V_{IN}$  higher than 6 V provides regulated 5 V output voltage.  $V_{IN}$  should be no higher than 36 V to avoid damaging the device. The current limit on the supply should be high enough to provide the needed supply current. Otherwise the supply voltage will not maintain the desired voltage. The supply voltage should be connected to the board with short and thick wires to handle the pulsing input current. If long cables are used to power up the board, the damping capacitor  $C_{BULK}$  located on the bottom side of board should be added, to avoid oscillation between the cable parasitic inductance and the low-ESR ceramic capacitors.

**VIN-EMI** — Input voltage to input filter of the converter

If the input filter is desired between the supply voltage and the LM73605/6, connect the supply voltage between VIN-EMI and GND-EMI. The supply voltage should be connected to the board with short and thick wires to handle pulsing input current.

**GND-EMI** — Ground connection near the input filter

This is the current return path for the supply connected to VIN-EMI. It provides a direct connection to the input filter capacitors to best filter the conducted noises generated from the PCB. Use VIN-EMI and GND-EMI connection if input filter is used and conducted EMI test is desired.

**Input Filter**—Prevent noise from contaminating supply voltage

The input filter consists of C-FLTs, L-IN and CBULK, located on the bottom side of the PCB. To include the input filter in the power path, connect the supply voltage between the VIN-EMI and GND-EMI connectors. The output of the filter is connected to the  $V_{IN}$  net, which is connected to the PVIN pins of the LM73605/LM73606 and the input capacitors. Note that the input filter components are not mounted on the PCB by default.

Conducted EMI arises from the normal operation of switching circuits. The ON and OFF actions of the power switches generate large discontinuous currents. The discontinuous currents are present at the input side of buck converters. Voltage ripple generated by discontinuous currents can be conducted to the voltage supply of the buck converter via physical contact of the conductors.

Without control, excessive input voltage ripple can compromise operation of the source. The input filter helps to smooth out the voltage perturbations leading to the source.

Preliminary EMI test results are shown in [Section 7.4](#).

**EN** — Test point to monitor the EN pin of the device

This test point is to monitor the voltage on the device EN pin.

**EN Jumper** — Set EN pin options

As noted on the board, this jumper is to select which voltage is used to enable the device.

1. PIN-1 to PIN-2: EN is connected to EN-EXT test point through a resistor divider;
2. PIN-2 to PIN-3 (default): EN is connected to  $V_{IN}$  through a resistor divider.

The divider,  $R_{ENT}$  and  $R_{ENB}$ , locates right above the EN jumper on the PCB.

The default setting is jumper on PIN-2 and PIN-3. The board will start when  $V_{IN}$  is about 3.5 V with this setting. The EN voltage is calculated by [Equation 1](#).

$$V_{EN} = V_{IN} \times R_{ENB} / (R_{ENT} + R_{ENB}) \quad (1)$$

When PIN-1 and PIN-2 are connected, the EN voltage is calculated by [Equation 2](#).

$$V_{EN} = V_{EN-EXT} \times R_{ENB} / (R_{ENT} + R_{ENB}) \quad (2)$$

If a resistor divider is not desired, the  $R_{ENB}$  can be removed from the board and the EN pin voltage will be equal to either EN-EXT or  $V_{IN}$  voltage, depending on the jumper location. It is recommended to keep  $R_{ENT}$  as a current limiting and noise filtering resistor at EN pin.

#### EN-EXT — External voltage input to drive EN

When EN jumper has PIN-1 and PIN-2 connected, the enable threshold is driven by the voltage on the EN-EXT test point. The EN pin voltage can be found by [Equation 2](#).

Remove  $R_{ENB}$  from the board if it is desired to have the same voltage on the EN pin as the EN-EXT voltage.

#### PGOOD — Test point to monitor the PGOOD pin

PGOOD test point is used to monitor the power-good flag. This flag indicates whether the output voltage has reached its regulation level. The PGOOD pin of the device is an open-drain output that is pulled up to  $V_{OUT}$  on this board through  $R_{PG}$  resistor.

#### SYNC/MODE Jumper — Operation mode setting and synchronization clock input

As noted on the PCB, the SYNC/MODE jumper is used to select the desired light-load operation mode.

1. PIN-1 to PIN-2: FPWM mode;
2. PIN-2 to PIN-3 (default): auto mode;
3. Open, connect external clock input to SYNC test point for synchronization and FPWM mode.

The default is PIN-2 and PIN-3 connected together and the device will operate in auto mode at light loads. With auto mode, discontinuous conduction mode (DCM) and pulse frequency modulation (PFM) mode are employed at light loads to provide high efficiency. PFM mode also provides very low quiescent current at no load. At heavier load, when inductor current is in DCM or continuous conduction mode (CCM) operation, the switching frequency is determined by the  $R_T$  resistor on the board, which is either 400 kHz or 2.2 MHz.

When PIN-1 and PIN-2 are connected, the device operates in the force PWM (FPWM) mode. In FPWM, the inductor current will be in CCM regardless of load. The switching frequency is the same at light loads as that of heavier loads. The switching frequency will be programmed by  $R_T$  resistor on the board, which is either 400 kHz or 2.2 MHz.

If synchronization to an external clock is desired, leave the SYNC/MODE jumper open and connect the clock input between SYNC test point and a GND test point. The device will operate in FPWM when it is synchronized to an external clock.

#### SYNC — Test point to monitor the SYNC/MODE pin and external clock input

The SYNC test point can be used to monitor the SYNC/MODE pin voltage on the device. It is also the external clock input if synchronization is needed. Connect the external clock input to the SYNC test point with the SYNC/MODE jumper open on all pins. The external clock frequency must be between 350 kHz and 2.2 MHz if used. The device operates in FPWM when synchronized to a clock.

#### VCC — Test point to monitor the VCC pin

This test point is to monitor the voltage at the VCC output.

#### Edge Connector — Additional connector to attach the EVM to a cable harness.

The edge connector provides the option of connecting the EVM to a cable harness if available. It includes the power connections:  $V_{IN}$ , GND,  $V_{OUT}$ , and  $V_{IN-EMI}$ . It also has Kelvin sense connections for  $V_{IN}$  ( $V_{IS}$ ),  $V_{OUT}$  ( $V_{OS\_P}$ ), and GND ( $V_{SNS-}$ ). See the schematic in [Figure 4](#) for all the signals connected to the edge connector.

### 4 Schematic

The three variants of the EVM shown in Table 2 share the same schematic with component variants shown in Section 6. The LM73605EVM\_5V\_400K Schematic is shown in Figure 4 as an example.

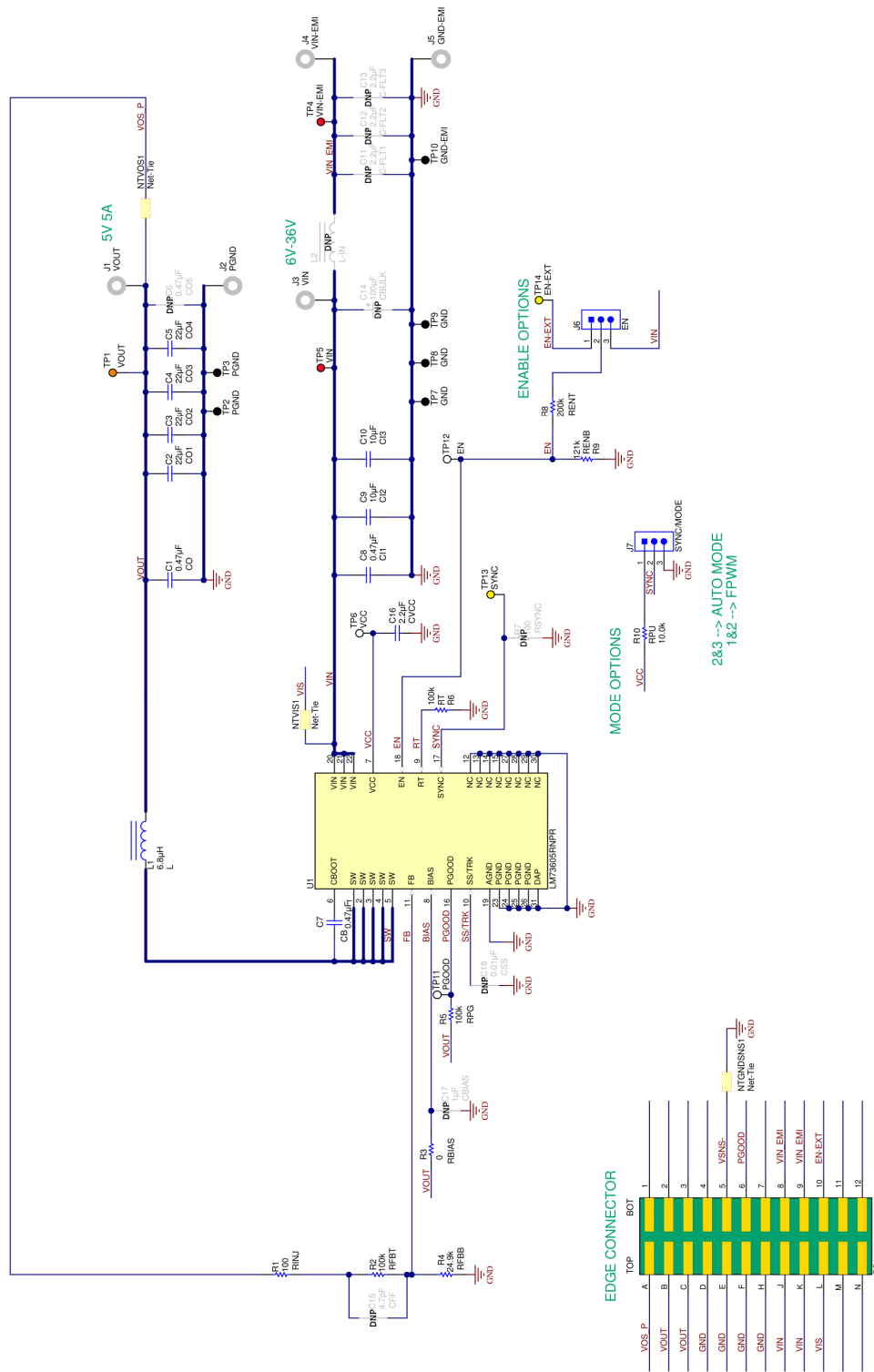


Figure 4. LM73605EVM\_5V\_400K Schematic

## 5 Board Layout

Figure 5 through Figure 9 show the board layout for the LM7360xEVM. The EVM offers resistors, capacitors, and test points to configure the output voltage, precision enable pin, set frequency and external clock synchronization.

The 30-pin WQFN package offers an exposed thermal pad which must be soldered to the copper landing on the PCB for optimal thermal performance. The PCB consists of a 4-layer design. There are 2-oz copper planes on the top and bottom and 1-oz copper mid-layer planes to dissipate heat with an array of thermal vias under the thermal pad to connect to all four layers.

Test points have been provided for ease of use to connect the power supply, required load and to monitor critical signals. The 12-pin edge connector can also be used to facilitate the use of a cable harness if one is required.

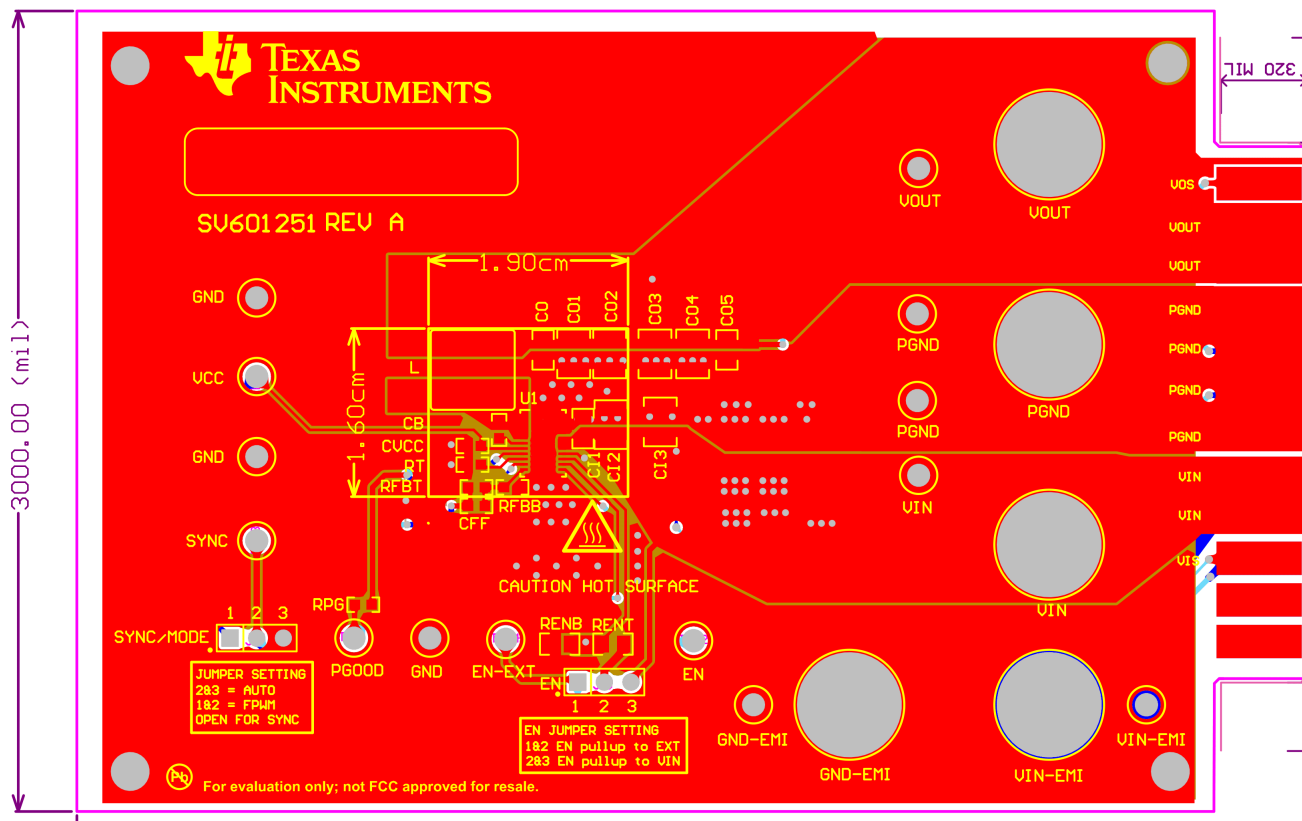
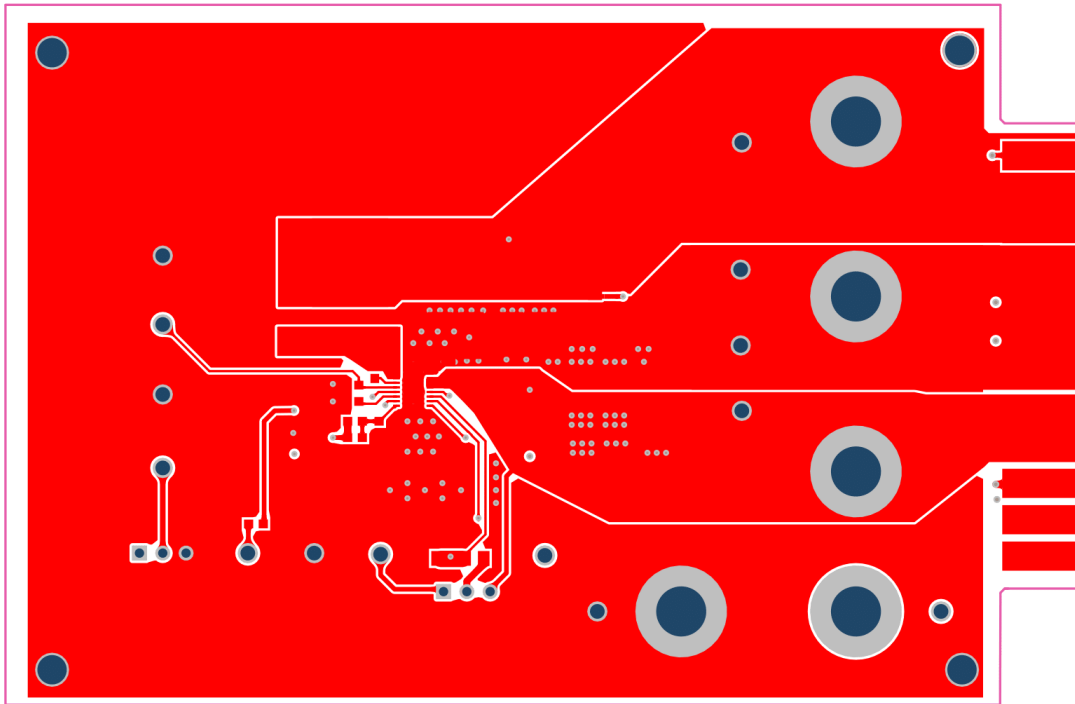
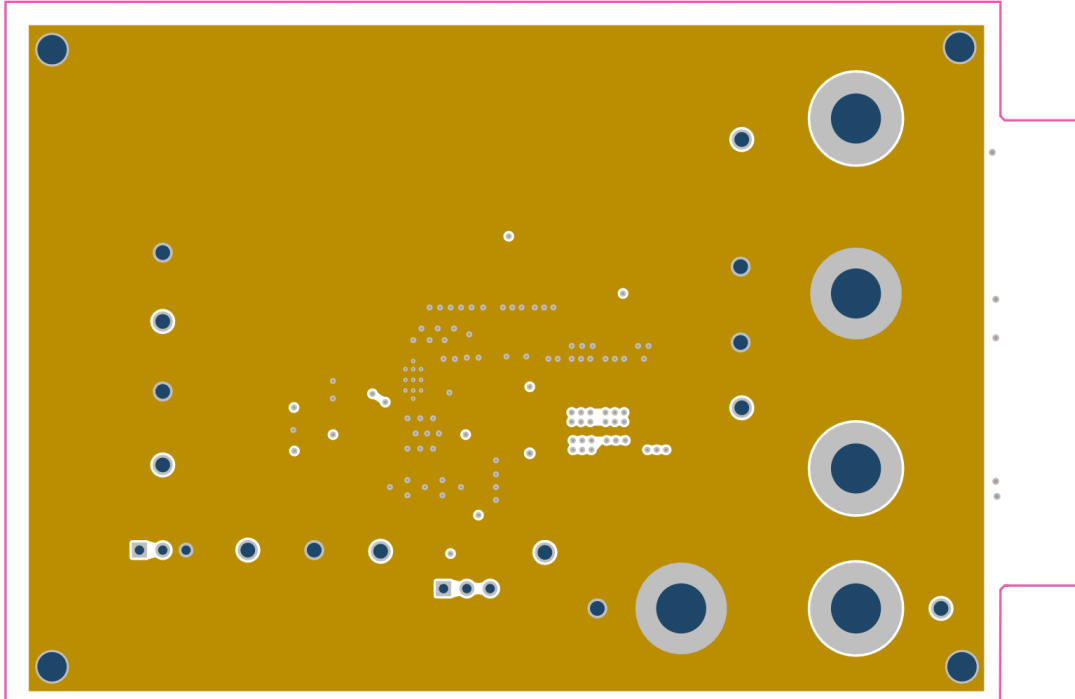


Figure 5. Top Layer and Silkscreen Layer





**Figure 6. Top Layer Routing**



**Figure 7. Mid-Layer 1 Ground Plane**



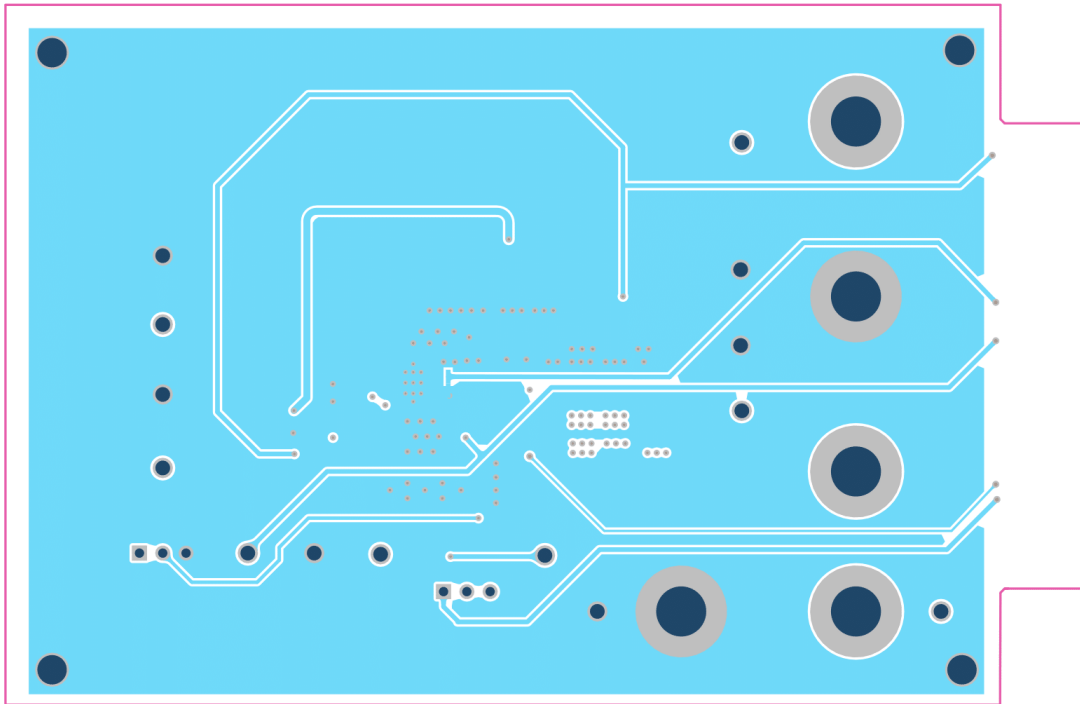


Figure 8. Mid-Layer 2 Routing

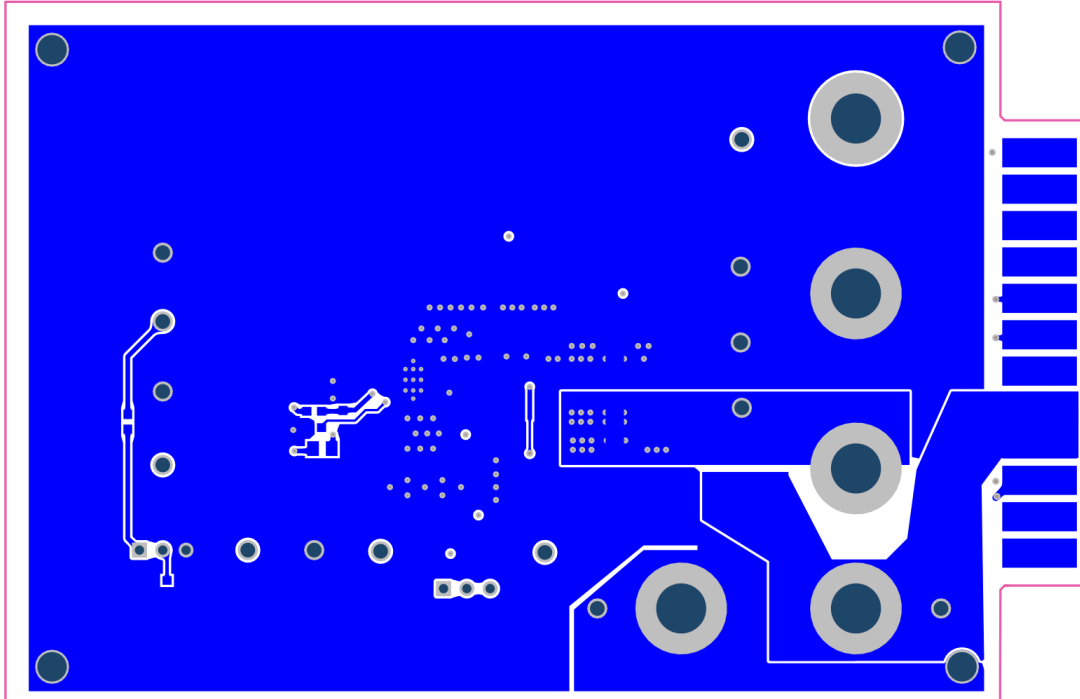


Figure 9. Bottom Layer Routing

## 6 Bill of Materials

There are three sets of variants for the LM73605/LM73606 EVM, as shown in [Table 2](#). The bills of materials of the three variants are shown in [Table 3](#), [Table 4](#) and [Table 5](#).

**Table 3. LM73605EVM-5V-2MHz 5-A 2.2-MHz EVM Bill of Materials**

Designator	Comment	Description	Manufacturer	Part Number	Quantity
C1, C8	CO, C11	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	2
C2, C3	CO1, CO2	CAP, CERM, 22 $\mu$ F, 16 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71C226KE18L	2
C7	CB	CAP, CERM, 0.47 $\mu$ F, 25V, +/-10%, X5R, 0603	MuRata	GRM188R61E474KA12D	1
C9	CI2	CAP, CERM, 10 $\mu$ F, 50 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71H106KA12L	1
C16	CVCC	CAP, CERM, 2.2 $\mu$ F, 10V, +/-10%, X6S, 0603	MuRata	GRM188C81A225KE34D	1
L1	L	Inductor, Shielded, Composite, 2.2 $\mu$ H, 17.8 A, 0.01 ohm, SMD	Coilcraft	XAL7070-222MEB	1
R1	RINJ	RES, 100, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805100RFKEA	1
R2, R5	RFBT, RPG	RES, 100 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100KFKEA	2
R3	RBIAS	RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	1
R4	RFBB	RES, 24.9 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060324K9FKEA	1
R6	RT	RES, 17.8 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060317K8FKEA	1
R8	RENT	RES, 200 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805200KFKEA	1
R9	RENB	RES, 121 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805121KFKEA	1
R10	RPU	RES, 10.0 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060310K0FKEA	1
U1	LM73605RNPR	3.5V to 36V 5A Synchronous Step-Down Voltage Regulator, RNP0030A (WQFN-30)	Texas Instruments	LM73605RNPR	1
C4, C5	CO3, CO4	CAP, CERM, 22 $\mu$ F, 16 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71C226KE18L	0
C6	CO5	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	0
C10	CI3	CAP, CERM, 10 $\mu$ F, 50 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71H106KA12L	0
C11, C12, C13	C-FLT1, C-FLT2, C-FLT3	CAP, CERM, 2.2 $\mu$ F, 50 V, +/- 10%, X5R, 1206	MuRata	GRM31CR61H225KA88L	0
C14	CBULK	CAP, AL, 100 $\mu$ F, 63 V, +/- 20%, 0.35 ohm, SMD	Panasonic	EEE-FK1J101P	0
C15	CFF	CAP, CERM, 4.7 pF, 50 V, +/- 5%, C0G/NP0, 0603	AVX	06035A4R7CAT2A	0
C17	CBIAS	CAP, CERM, 1 $\mu$ F, 25 V, +/- 10%, X7R, 0603	Kemet	C0603C105K3RACTU	0
C18	CSS	CAP, CERM, 0.01 $\mu$ F, 100 V, +/- 20%, X7R, 0603	AVX	06031C103MAT2A	0
L2	L-IN	Inductor, Shielded, Composite, 2.2 $\mu$ H, 12.9A, 0.0137 ohm, SMD	Coilcraft	XAL7030-222MEB	0
R7	RSYNC	RES, 100, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100RFKEA	0

**Table 4. LM73605EVM-5V-400K 5-A 400-kHz EVM Bill of Materials**

Designator	Comment	Description	Manufacturer	Part Number	Quantity
C1, C8	CO, C11	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	2
C2, C3, C4, C5	CO1, CO2, CO3, CO4	CAP, CERM, 22 $\mu$ F, 16 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71C226KE18L	4
C7	CB	CAP, CERM, 0.47 $\mu$ F, 25V, +/-10%, X5R, 0603	MuRata	GRM188R61E474KA12D	1
C9, C10	CI2, CI3	CAP, CERM, 10 $\mu$ F, 50 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71H106KA12L	2
C16	CVCC	CAP, CERM, 2.2 $\mu$ F, 10V, +/-10%, X6S, 0603	MuRata	GRM188C81A225KE34D	1
L1	L	Inductor, Shielded, Composite, 6.8 $\mu$ H, 9.2 A, 0.02 ohm, SMD	Coilcraft	XAL7070-682MEB	1
R1	RINJ	RES, 100, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805100RFKEA	1
R2, R5, R6	RFBT, RPG, RT	RES, 100 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100KFKEA	3
R3	RBIAS	RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	1
R4	RFBFB	RES, 24.9 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060324K9FKEA	1
R8	RENT	RES, 200 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805200KFKEA	1
R9	RENB	RES, 121 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805121KFKEA	1
R10	RPU	RES, 10.0 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060310K0FKEA	1
U1	LM73605RNPR	3.5V to 36V 5A Synchronous Step-Down Voltage Regulator, RNP0030A (WQFN-30)	Texas Instruments	LM73605RNPR	1
C6	CO5	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	0
C11, C12, C13	C-FLT1, C-FLT2, C-FLT3	CAP, CERM, 2.2 $\mu$ F, 50 V, +/- 10%, X5R, 1206	MuRata	GRM31CR61H225KA88L	0
C14	CBULK	CAP, AL, 100 $\mu$ F, 63 V, +/- 20%, 0.35 ohm, SMD	Panasonic	EEE-FK1J101P	0
C15	CFF	CAP, CERM, 4.7 pF, 50 V, +/- 5%, C0G/NP0, 0603	AVX	06035A4R7CAT2A	0
C17	CBIAS	CAP, CERM, 1 $\mu$ F, 25 V, +/- 10%, X7R, 0603	Kemet	C0603C105K3RACTU	0
C18	CSS	CAP, CERM, 0.01 $\mu$ F, 100 V, +/- 20%, X7R, 0603	AVX	06031C103MAT2A	0
L2	L-IN	Inductor, Shielded, Composite, 2.2 $\mu$ H, 12.9A, 0.0137 ohm, SMD	Coilcraft	XAL7030-222MEB	0
R7	RSYNC	RES, 100, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100RFKEA	0

**Table 5. LM73606EVM-5V-400K 6-A 400-kHz EVM Bill of Materials**

Designator	Comment	Description	Manufacturer	Part Number	Quantity
C1, C8	CO, C11	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	2
C2, C3, C4, C5	CO1, CO2, CO3, CO4	CAP, CERM, 22 $\mu$ F, 16 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71C226KE18L	4
C7	CB	CAP, CERM, 0.47 $\mu$ F, 25V, +/-10%, X5R, 0603	MuRata	GRM188R61E474KA12D	1
C9, C10	CI2, CI3	CAP, CERM, 10 $\mu$ F, 50 V, +/- 10%, X7R, 1210	MuRata	GRM32ER71H106KA12L	2
C16	CVCC	CAP, CERM, 2.2 $\mu$ F, 10V, +/-10%, X6S, 0603	MuRata	GRM188C81A225KE34D	1
L1	L	Inductor, Shielded, Composite, 6.8 $\mu$ H, 9.2 A, 0.02 ohm, SMD	Coilcraft	XAL7070-682MEB	1
R1	RINJ	RES, 100, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805100RFKEA	1
R2, R5, R6	RFBT, RPG, RT	RES, 100 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100KFKEA	3
R3	RBIAS	RES, 0, 5%, 0.1 W, 0603	Vishay-Dale	CRCW06030000Z0EA	1
R4	RFBB	RES, 24.9 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060324K9FKEA	1
R8	RENT	RES, 200 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805200KFKEA	1
R9	RENB	RES, 121 k, 1%, 0.125 W, 0805	Vishay-Dale	CRCW0805121KFKEA	1
R10	RPU	RES, 10.0 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW060310K0FKEA	1
U1	LM73606RNPR	3.5V to 36V 5A Synchronous Step-Down Voltage Regulator, RNP0030A (WQFN-30)	Texas Instruments	LM73606RNPR	1
C6	CO5	CAP, CERM, 0.47 $\mu$ F, 50 V, +/- 10%, X7R, 0805	MuRata	GRM21BR71H474KA88L	0
C11, C12, C13	C-FLT1, C-FLT2, C-FLT3	CAP, CERM, 2.2 $\mu$ F, 50 V, +/- 10%, X5R, 1206	MuRata	GRM31CR61H225KA88L	0
C14	CBULK	CAP, AL, 100 $\mu$ F, 63 V, +/- 20%, 0.35 ohm, SMD	Panasonic	EEE-FK1J101P	0
C15	CFF	CAP, CERM, 4.7 pF, 50 V, +/- 5%, C0G/NP0, 0603	AVX	06035A4R7CAT2A	0
C17	CBIAS	CAP, CERM, 1 $\mu$ F, 25 V, +/- 10%, X7R, 0603	Kemet	C0603C105K3RACTU	0
C18	CSS	CAP, CERM, 0.01 $\mu$ F, 100 V, +/- 20%, X7R, 0603	AVX	06031C103MAT2A	0
L2	L-IN	Inductor, Shielded, Composite, 2.2 $\mu$ H, 12.9A, 0.0137 ohm, SMD	Coilcraft	XAL7030-222MEB	0
R7	RSYNC	RES, 100, 1%, 0.1 W, 0603	Vishay-Dale	CRCW0603100RFKEA	0

## 7 Performance Curves

### 7.1 LM73605EVM-5V-2MHz 5-A 2.2-MHz Board Curves

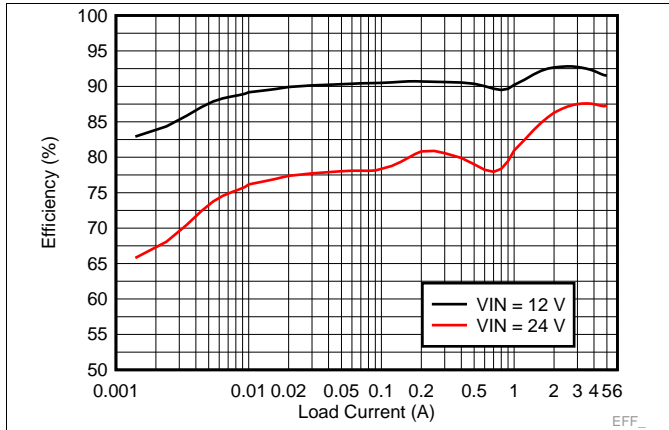


Figure 10. LM73605 5-V 2.2-MHz Efficiency in Auto Mode

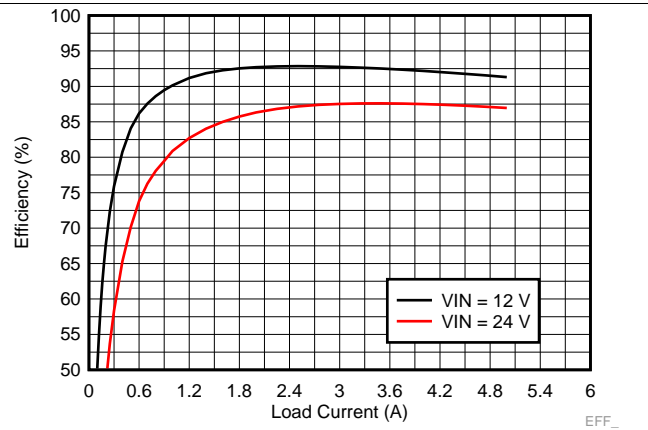


Figure 11. LM73605 5-V 2.2-MHz Efficiency in FPWM Mode

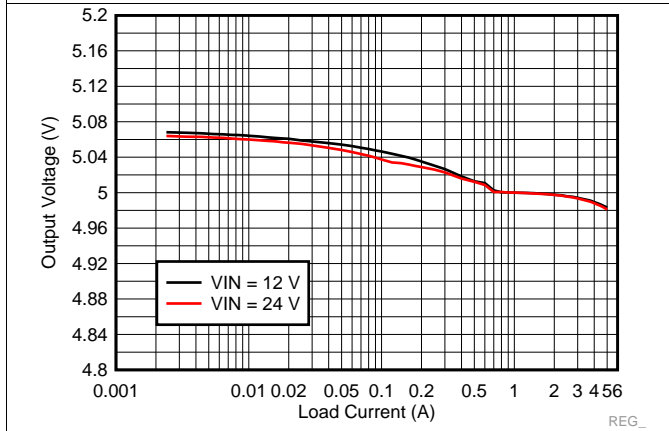


Figure 12. LM73605 5-V 2.2-MHz  $V_{OUT}$  Regulation in Auto Mode

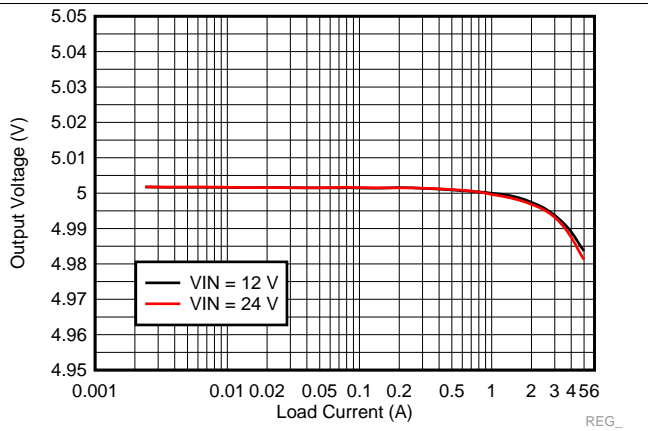


Figure 13. LM73605 5-V 2.2-MHz  $V_{OUT}$  Regulation in FPWM Mode

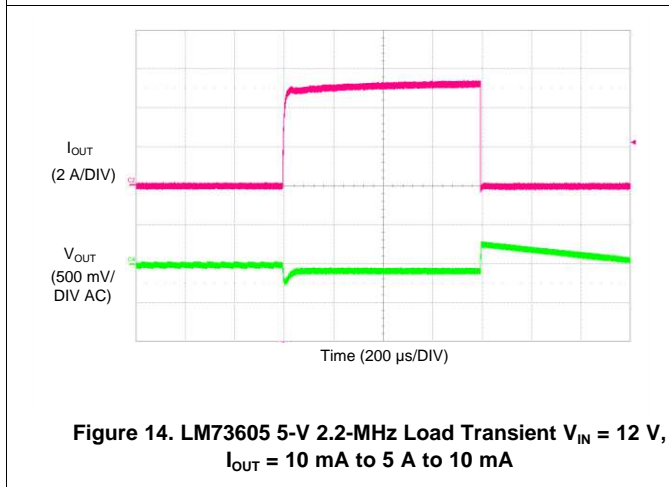


Figure 14. LM73605 5-V 2.2-MHz Load Transient  $V_{IN} = 12\text{ V}$ ,  $I_{OUT} = 10\text{ mA to } 5\text{ A to } 10\text{ mA}$

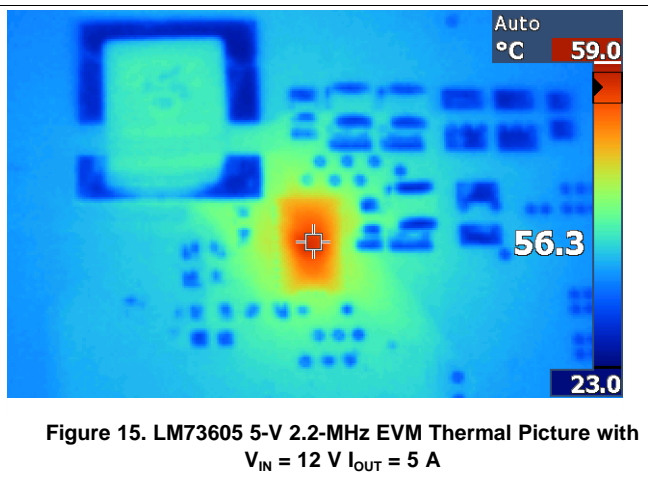


Figure 15. LM73605 5-V 2.2-MHz EVM Thermal Picture with  $V_{IN} = 12\text{ V}$   $I_{OUT} = 5\text{ A}$

7.2 LM73605EVM-5V-400K 5-A 400-kHz Board Curves

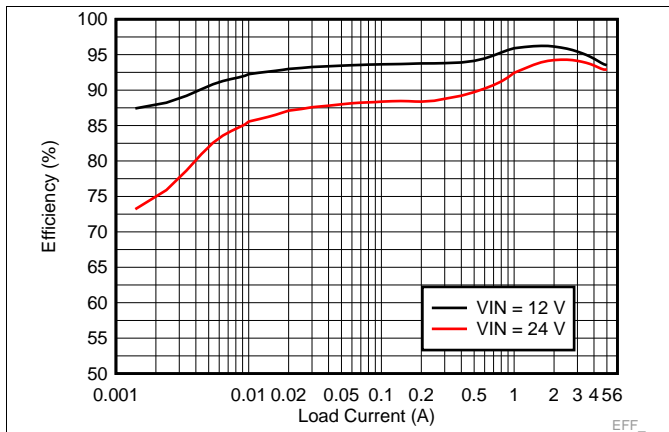


Figure 16. LM73605 5-V 400-kHz Efficiency in Auto Mode

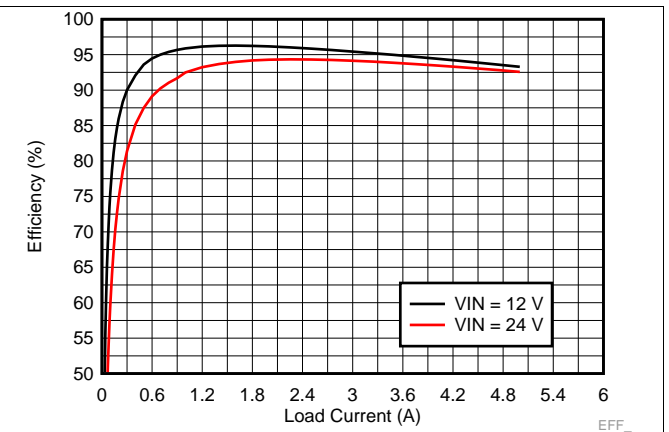


Figure 17. LM73605 5-V 400-kHz Efficiency in FPWM Mode

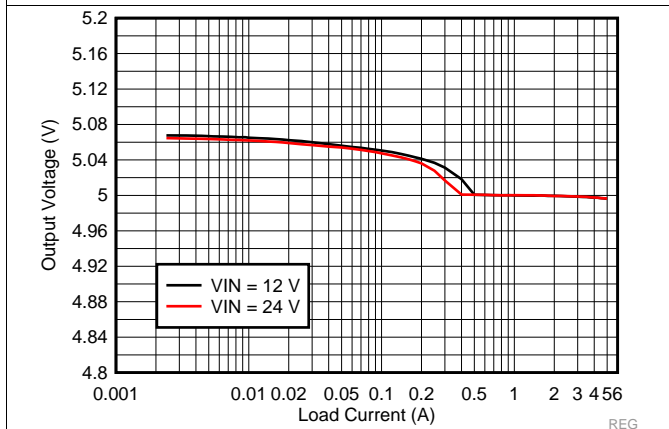


Figure 18. LM73605 5-V 400-kHz  $V_{OUT}$  Regulation in Auto Mode

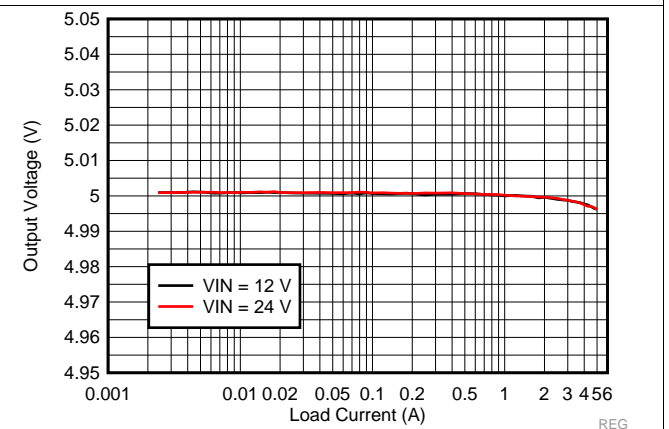


Figure 19. LM73605 5-V 400-kHz  $V_{OUT}$  Regulation in FPWM Mode

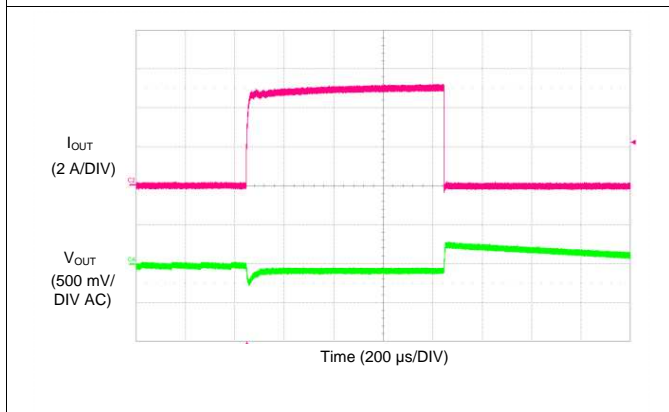


Figure 20. LM73605 5-V 400-kHz Load Transient  $V_{IN} = 12\text{ V}$ ,  $I_{OUT} = 10\text{ mA}$  to  $5\text{ A}$  to  $10\text{ mA}$

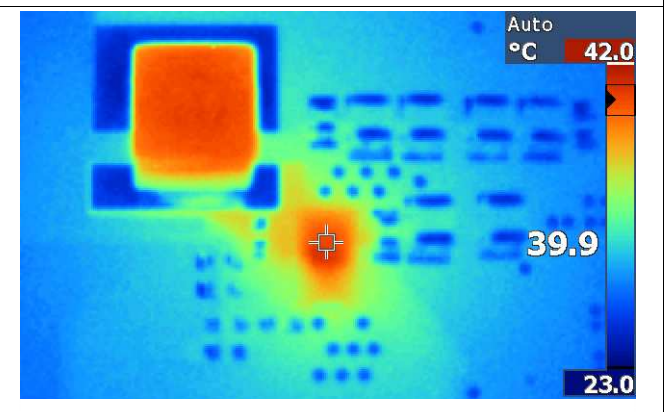


Figure 21. LM73605 5-V 400-kHz EVM Thermal Picture with  $V_{IN} = 12\text{ V}$   $I_{OUT} = 5\text{ A}$

### 7.3 LM73606EVM-5V-400K 6-A 400-kHz Board Curves

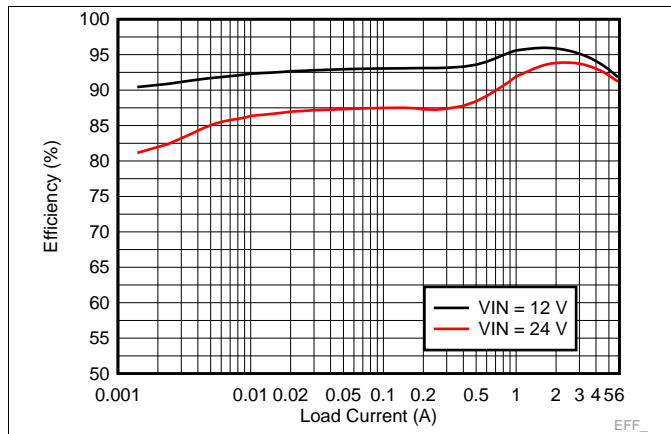


Figure 22. LM73606 5-V 400-kHz Efficiency in Auto Mode

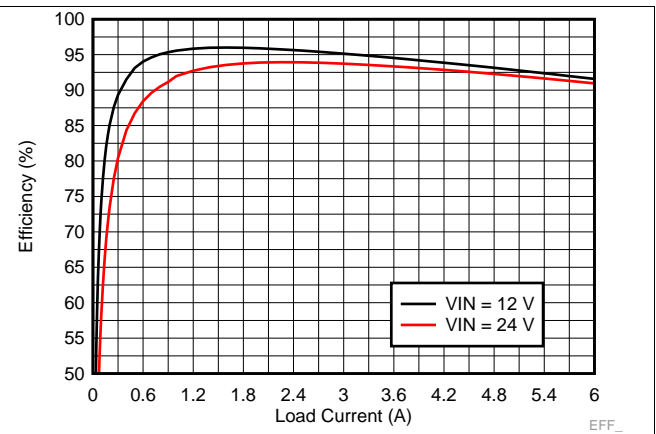


Figure 23. LM73606 5-V 400-kHz Efficiency in FPWM Mode

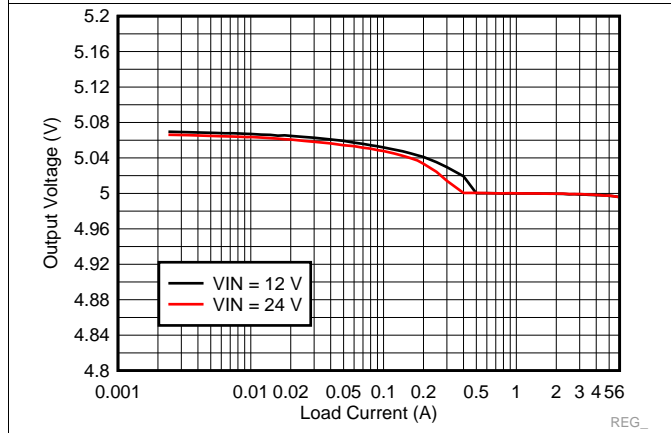


Figure 24. LM73606 5-V 400-kHz  $V_{OUT}$  Regulation in Auto Mode

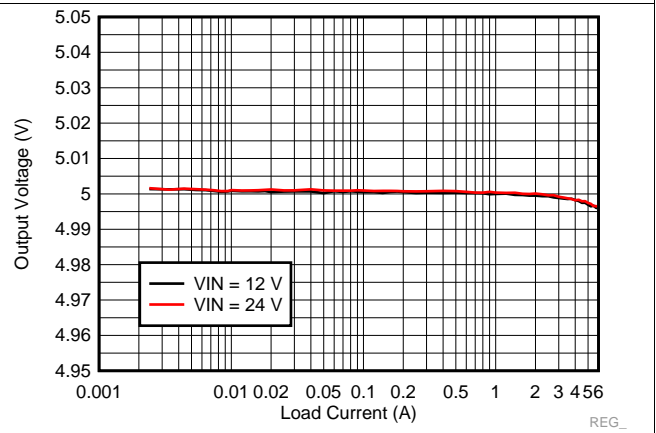


Figure 25. LM73606 5-V 400-kHz  $V_{OUT}$  Regulation in FPWM Mode

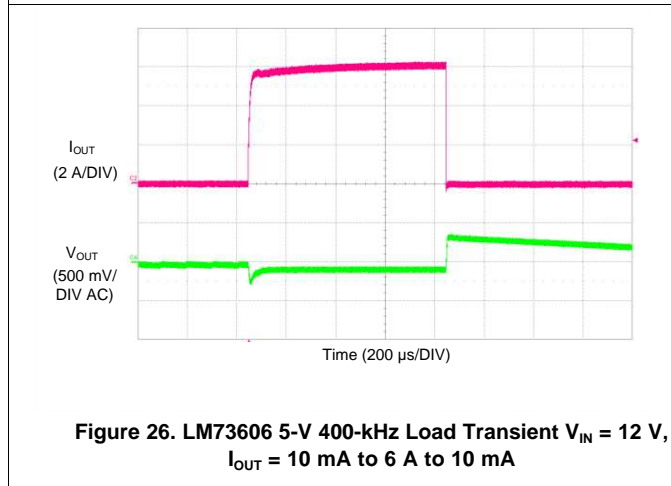


Figure 26. LM73606 5-V 400-kHz Load Transient  $V_{IN} = 12\text{ V}$ ,  $I_{OUT} = 10\text{ mA}$  to  $6\text{ A}$  to  $10\text{ mA}$

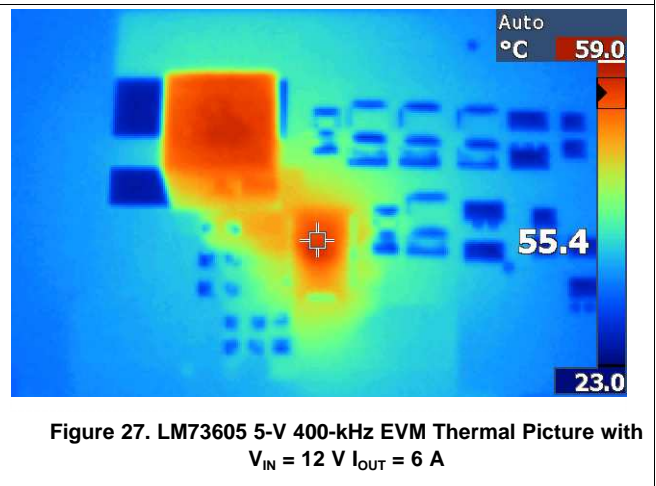


Figure 27. LM73605 5-V 400-kHz EVM Thermal Picture with  $V_{IN} = 12\text{ V}$   $I_{OUT} = 6\text{ A}$

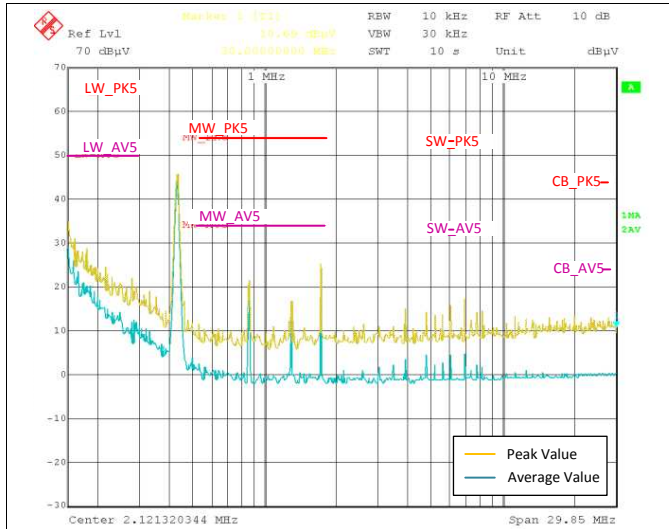


### 7.4 EMI Test Results

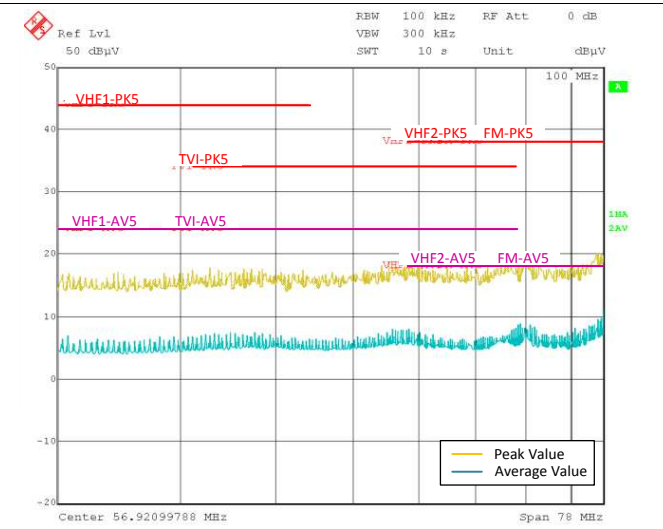
The following results were obtained in TI labs for reference only. The radiated EMI test was performed in a 3-meter standard lab. The input filter values used for this test is shown in [Table 6](#). The input filter consists of C-FLTs, L-IN and CBULK, located on the bottom side of the PCB. Note that the input filter components are not mounted on the PCB by default.

**Table 6. EMI Filter Component Values**

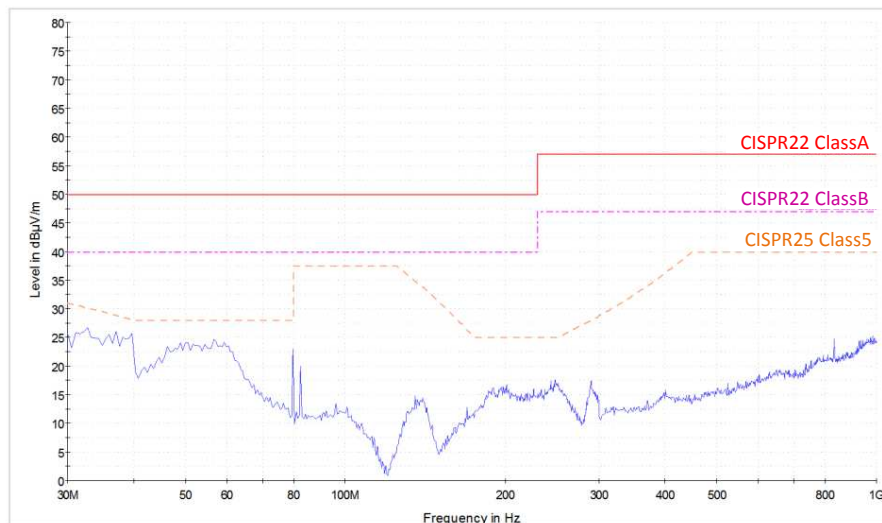
Component	C-FLTs	L-IN	CBULK
Value	4.7 $\mu$ F ceramic capacitor	1 $\mu$ H	10 $\mu$ F electrolytic capacitor
Quantity	4	1	1



**Figure 28. LM73605 400-kHz Board Conducted EMI Result vs CISPR25 Limits, with  $I_{OUT} = 4$  A - Low Frequency**



**Figure 29. LM73605 400-kHz Board Conducted EMI Result vs CISPR25 Limits, with  $I_{OUT} = 4$  A - High Frequency**



**Figure 30. LM73605 400-kHz Board Radiated EMI Result vs CISPR25 Limits, with  $I_{OUT} = 4$  A**

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1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
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  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
  - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
  - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
3. *Regulatory Notices:*
  - 3.1 *United States*
    - 3.1.1 *Notice applicable to EVMs not FCC-Approved:*

**FCC NOTICE:** This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.
    - 3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

### CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### FCC Interference Statement for Class A EVM devices

*NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.*

## FCC Interference Statement for Class B EVM devices

*NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:*

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

#### Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

### 3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see [http://www.tij.co.jp/lstds/ti\\_ja/general/eStore/notice\\_01.page](http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page) 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。  
[http://www.tij.co.jp/lstds/ti\\_ja/general/eStore/notice\\_01.page](http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page)

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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3. 技術基準適合証明を取得後ご使用いただく。

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#### 3.4 *European Union*

##### 3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

#### 4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

##### 4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

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